

### General Description

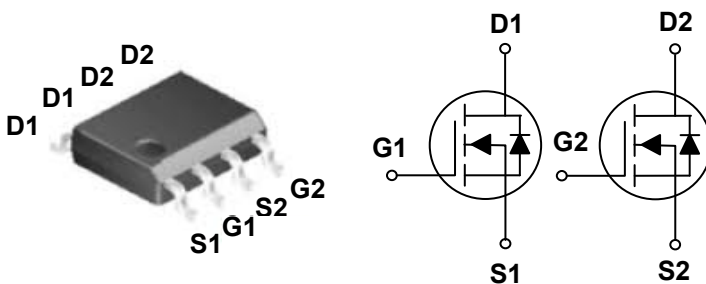
These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BVDSS	RDSON	ID
40V	15mΩ	10A

### Features

- 40V, 10A,  $R_{DS(ON)} = 15m\Omega @ V_{GS} = 10V$
- Improved dv/dt capability
- Fast switching
- 100% EAS Guaranteed
- Green Device Available

### SOP8 Dual Pin Configuration



### Applications

- Motor Drive
- Power Tools
- LED Lighting



### Absolute Maximum Ratings $T_c=25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	40	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D$	Drain Current – Continuous ( $T_C=25^\circ\text{C}$ )	10	A
	Drain Current – Continuous ( $T_C=100^\circ\text{C}$ )	6.3	A
$I_{DM}$	Drain Current – Pulsed <sup>1</sup>	40	A
EAS	Single Pulse Avalanche Energy <sup>2</sup>	76	mJ
IAS	Single Pulse Avalanche Current <sup>2</sup>	39	A
$P_D$	Power Dissipation ( $T_C=25^\circ\text{C}$ )	2.1	W
	Power Dissipation – Derate above $25^\circ\text{C}$	0.017	W/ $^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-50 to 150	$^\circ\text{C}$
$T_J$	Operating Junction Temperature Range	-50 to 150	$^\circ\text{C}$

### Thermal Characteristics

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction to ambient	---	60	$^\circ\text{C/W}$

**Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)**
**Off Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	40	---	---	V
$I_{DSS}$	Drain-Source Leakage Current	$V_{DS}=40V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	1	$\mu A$
		$V_{DS}=32V, V_{GS}=0V, T_J=125^\circ\text{C}$	---	---	10	$\mu A$
$I_{GSS}$	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$	---	---	$\pm 100$	nA

**On Characteristics**

$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS}=10V, I_D=8A$	---	12	15	m $\Omega$
		$V_{GS}=4.5V, I_D=6A$	---	15	20	m $\Omega$
$V_{GS(th)}$	Gate Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\mu A$	1.2	1.8	2.5	V
gfs	Forward Transconductance	$V_{DS}=10V, I_D=1A$	---	5	---	S

**Dynamic and switching Characteristics**

$Q_g$	Total Gate Charge <sup>3,4</sup>	$V_{DS}=20V, V_{GS}=4.5V, I_D=10A$	---	13	26	nC
$Q_{gs}$	Gate-Source Charge <sup>3,4</sup>		---	4	8	
$Q_{gd}$	Gate-Drain Charge <sup>3,4</sup>		---	5.3	10	
$T_{d(on)}$	Turn-On Delay Time <sup>3,4</sup>	$V_{DD}=20V, V_{GS}=10V, R_G=6\Omega, I_D=1A$	---	8	16	ns
$T_r$	Rise Time <sup>3,4</sup>		---	3.2	8	
$T_{d(off)}$	Turn-Off Delay Time <sup>3,4</sup>		---	26.4	52	
$T_f$	Fall Time <sup>3,4</sup>		---	3.8	8	
$C_{iss}$	Input Capacitance	$V_{DS}=20V, V_{GS}=0V, F=1\text{MHz}$	---	1088	2000	pF
$C_{oss}$	Output Capacitance		---	110	200	
$C_{rss}$	Reverse Transfer Capacitance		---	80	160	
$R_g$	Gate resistance	$V_{GS}=0V, V_{DS}=0V, F=1\text{MHz}$	---	3	6	$\Omega$

**Drain-Source Diode Characteristics and Maximum Ratings**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_S$	Continuous Source Current	$V_G=V_D=0V, \text{Force Current}$	---	---	10	A
$I_{SM}$	Pulsed Source Current		---	---	20	A
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V, I_S=1A, T_J=25^\circ\text{C}$	---	---	1	V

Note :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.
2.  $V_{DD}=25V, V_{GS}=10V, L=0.1\text{mH}, I_{AS}=39A, R_G=25\Omega$ , Starting  $T_J=25^\circ\text{C}$ .
3. The data tested by pulsed, pulse width  $\leq 300\mu s$ , duty cycle  $\leq 2\%$ .
4. Essentially independent of operating temperature.

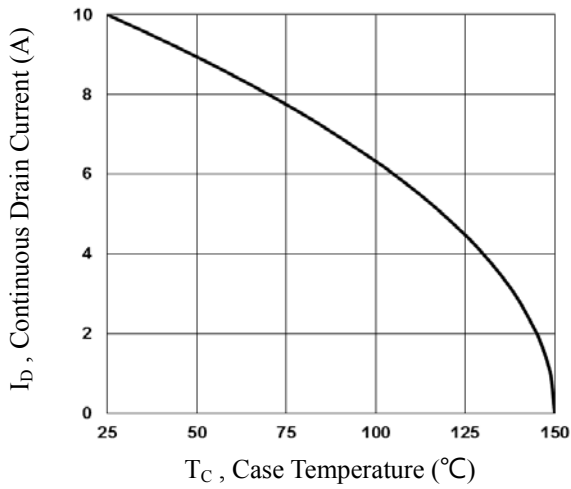


Fig.1 Continuous Drain Current vs.  $T_C$

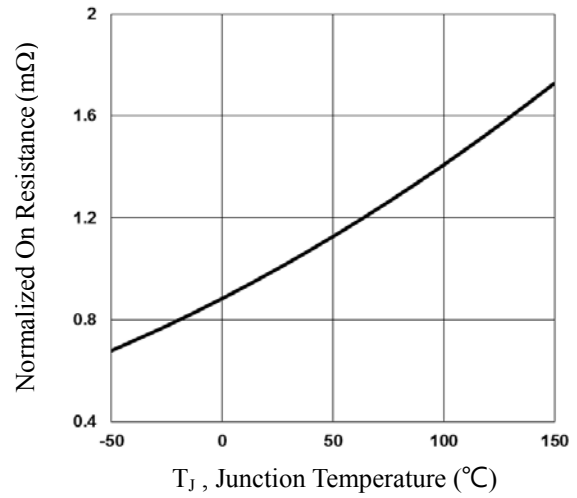


Fig.2 Normalized  $R_{DS(on)}$  vs.  $T_J$

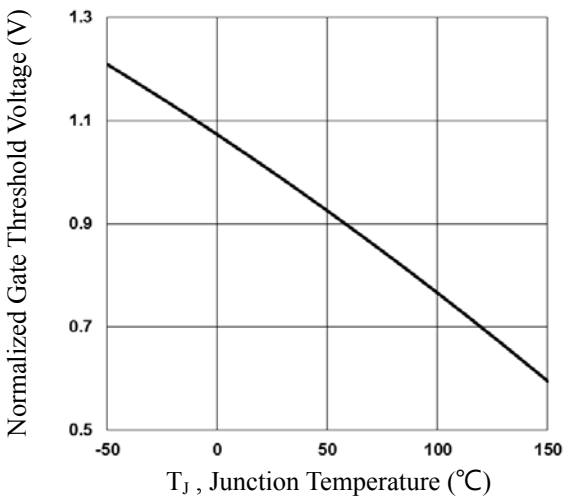


Fig.3 Normalized  $V_{th}$  vs.  $T_J$

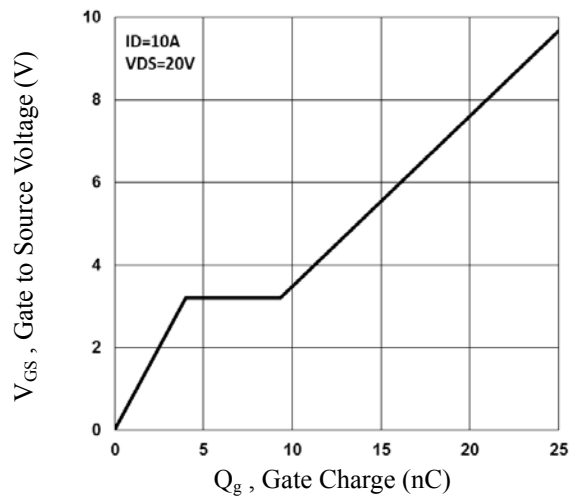


Fig.4 Gate Charge Waveform

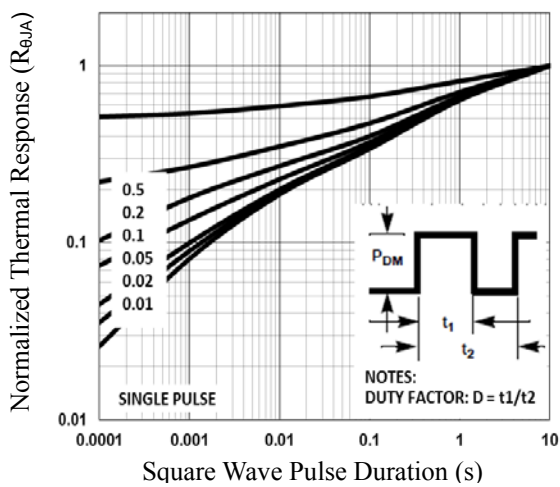


Fig.5 Normalized Transient Impedance

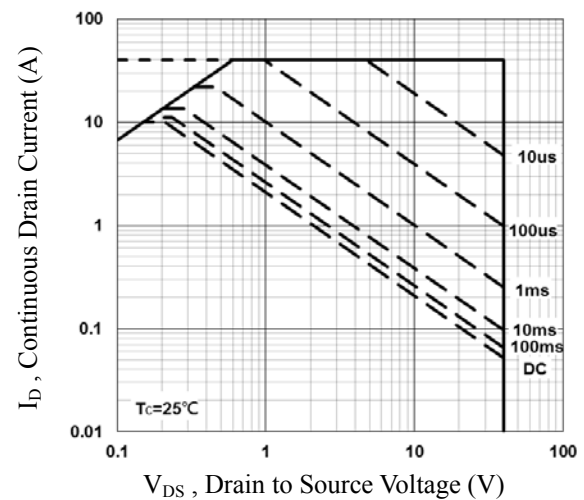


Fig.6 Maximum Safe Operation Area

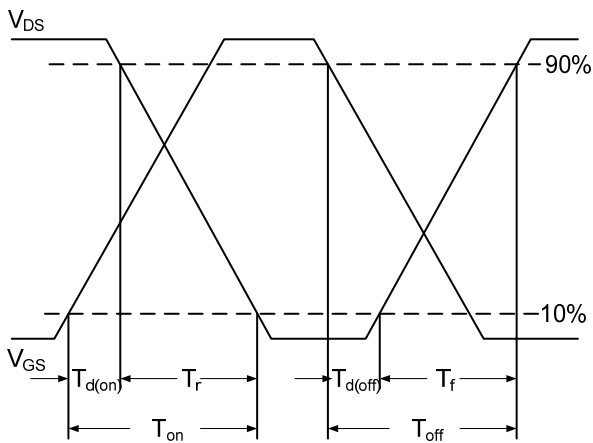


Fig.7 Switching Time Waveform

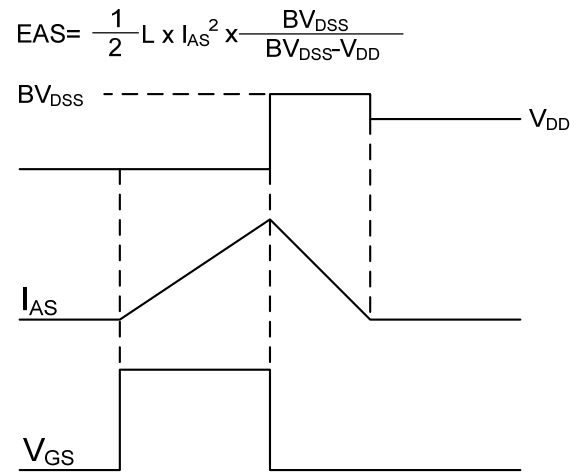
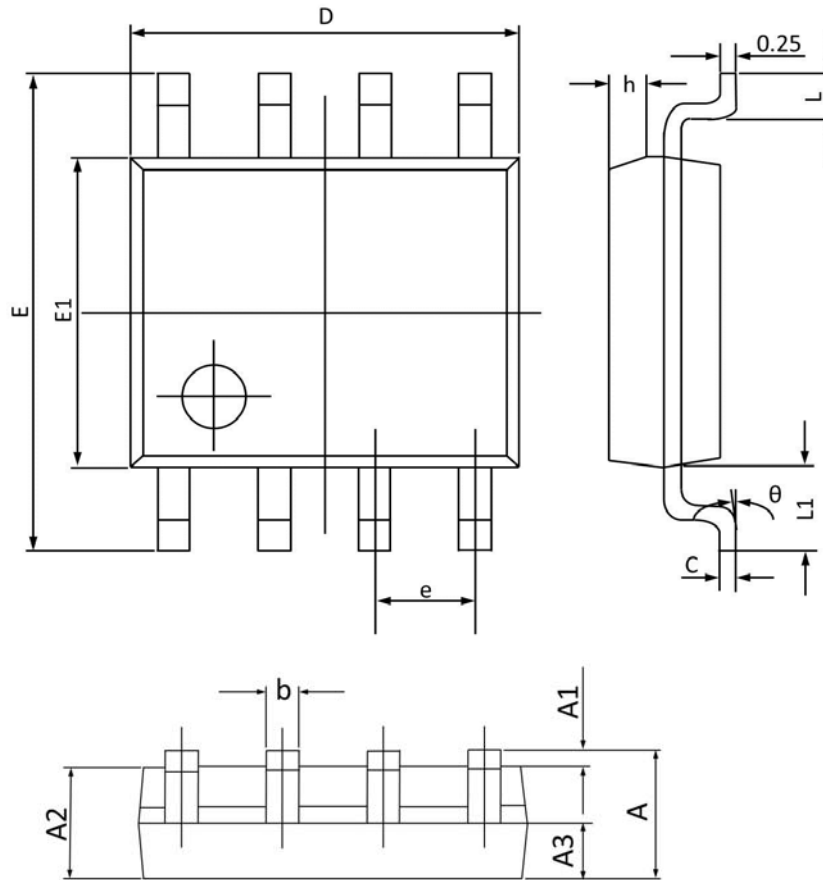


Fig.8 EAS Waveform



## SOP8 PACKAGE INFORMATION



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.068
A1	0.100	0.250	0.004	0.009
A2	1.300	1.500	0.052	0.059
A3	0.600	0.700	0.024	0.027
b	0.390	0.480	0.016	0.018
c	0.210	0.260	0.009	0.010
D	4.700	5.100	0.186	0.200
E	5.800	6.200	0.229	0.244
E1	3.700	4.100	0.146	0.161
e	1.270(BSC)		0.050(BSC)	
h	0.250	0.500	0.010	0.019
L	0.500	0.800	0.019	0.031
L1	1.050(BSC)		0.041(BSC)	
theta	0°	8°	0°	8°